

Quantitative study of the transition layers in Mo/Si multilayer from the analysis of the Si K β x-ray emission band

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30
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GRUPEMENT NATIONAL DE
MICROSCOPIE ELECTRONIQUE A BALAYAGE
ET DE MICROANALYSES

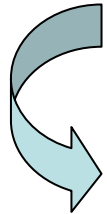
En convention de coopération avec la Société Française de Physique



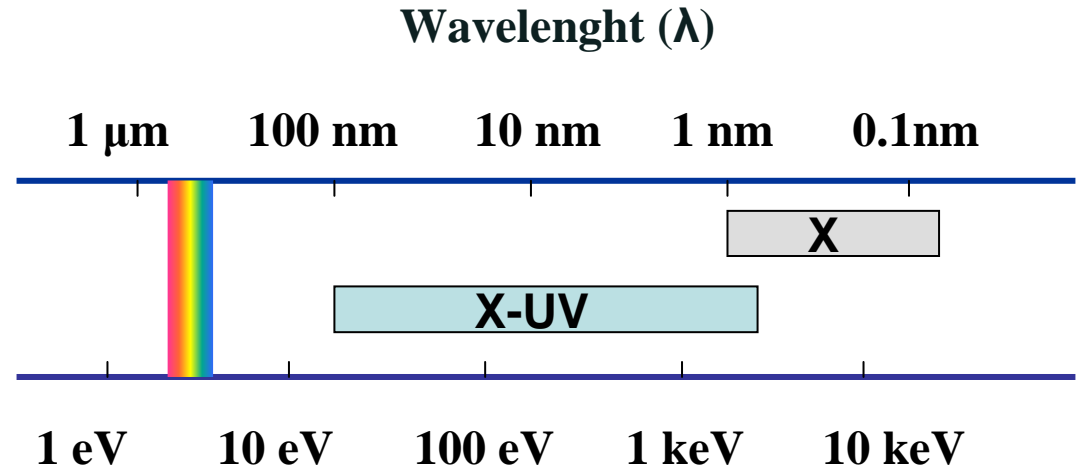
X-UV multilayer interferential mirrors (MIM)



Optical components in the X-UV range

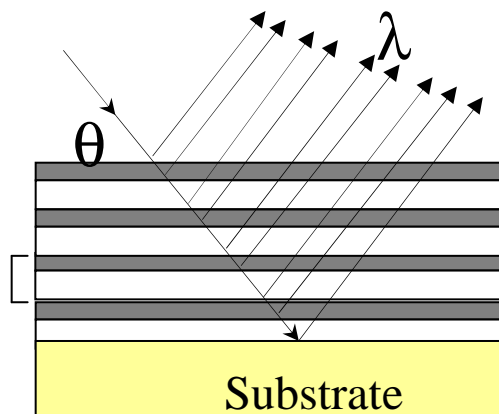


Consist in periodic stacks of ultrathin layers with nanometer thickness



■ Absorbing material (Mo, W...)

□ Light material (Si, C, B₄C...)



Photon Energy

$d = d \text{ absorbing} + d \text{ light}$

$$2d \sin\theta \sqrt{1 - \frac{2\delta}{\sin^2\theta}} = k\lambda$$

Bragg's law corrected by the effects of refraction

δ is the bilayer weighted real part of the refractive index

X-UV Multilayer interferential mirrors (MIM)



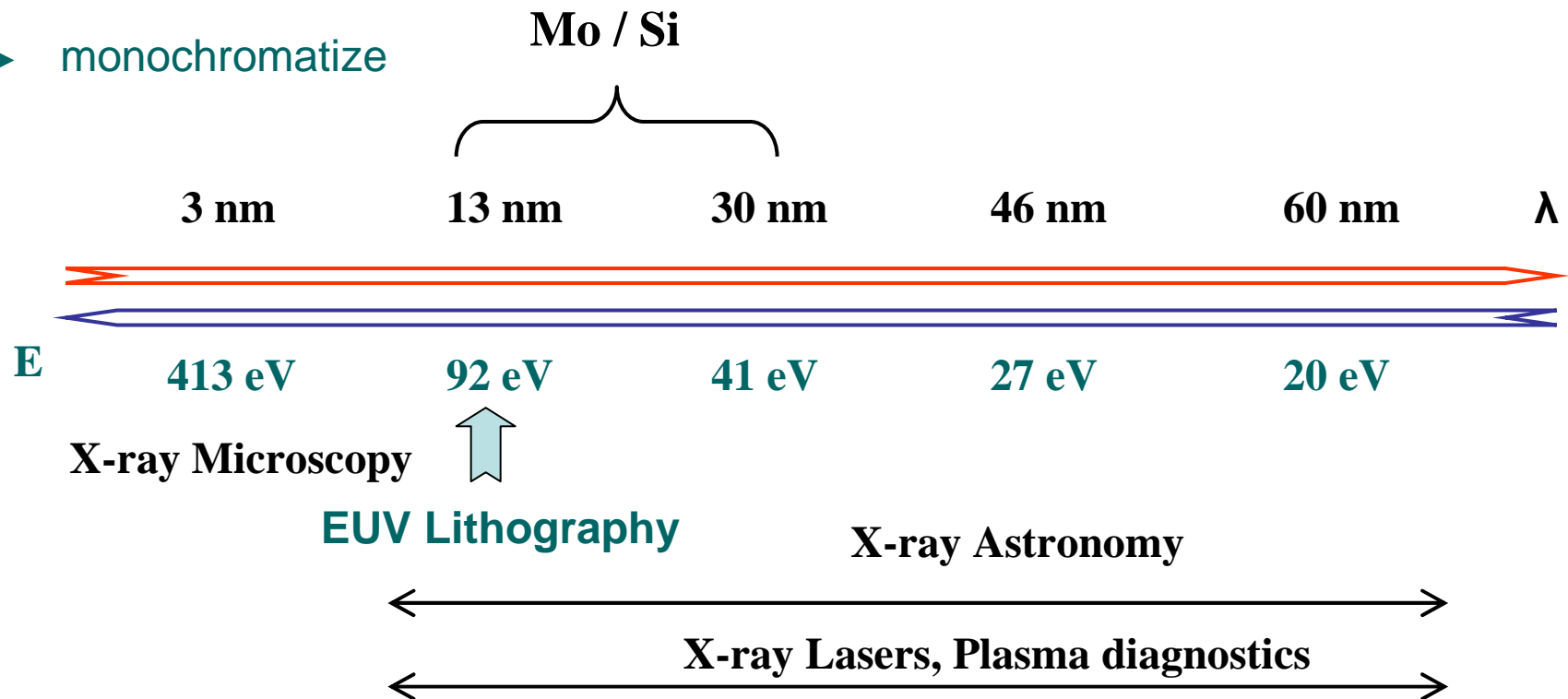
Structures at the basis of various devices because :

- reflect
- image
- focus
- polarize
- monochromatize

X-rays



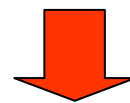
Many applications



MIM's performances depend on the quality of their interfaces

Thermal treatments enhance the diffusion processes at the interfaces

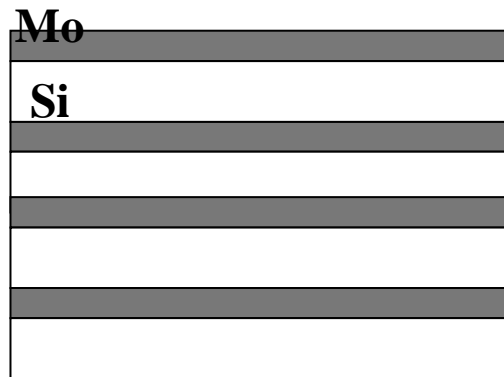
GOAL



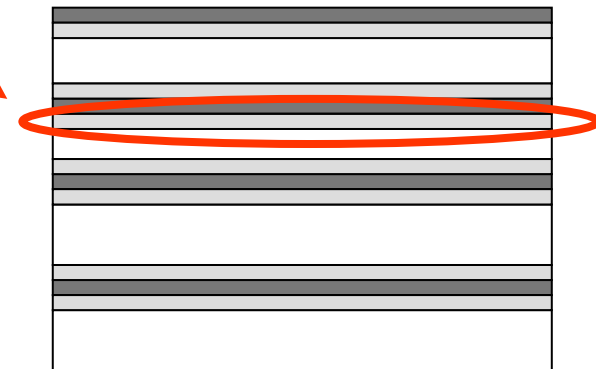
to probe the transition layer



to determine its nature and thickness

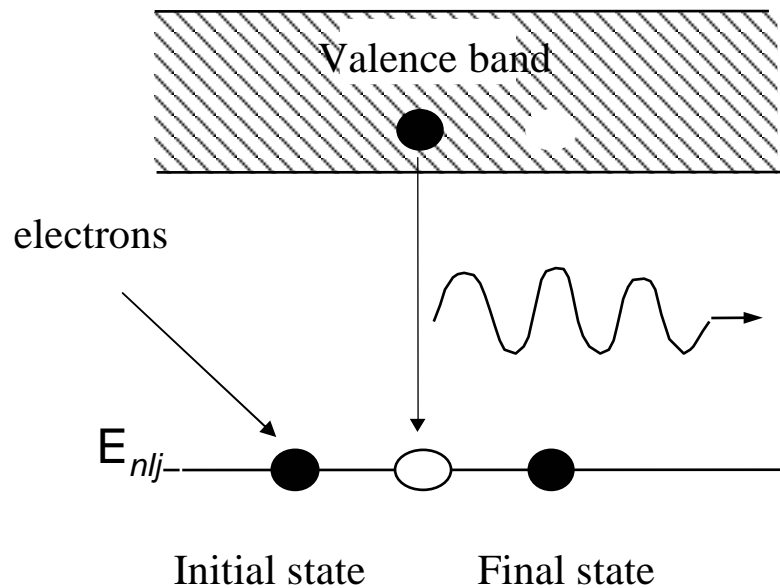


Perfect Mo /Si MIM

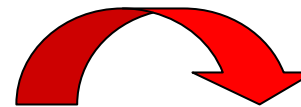


Mo / Si MIM affected by interdiffusion

X-RAY EMISSION SPECTROSCOPY INDUCED BY ELECTRONS (XES)



Study of buried layers and interlayers non destructively



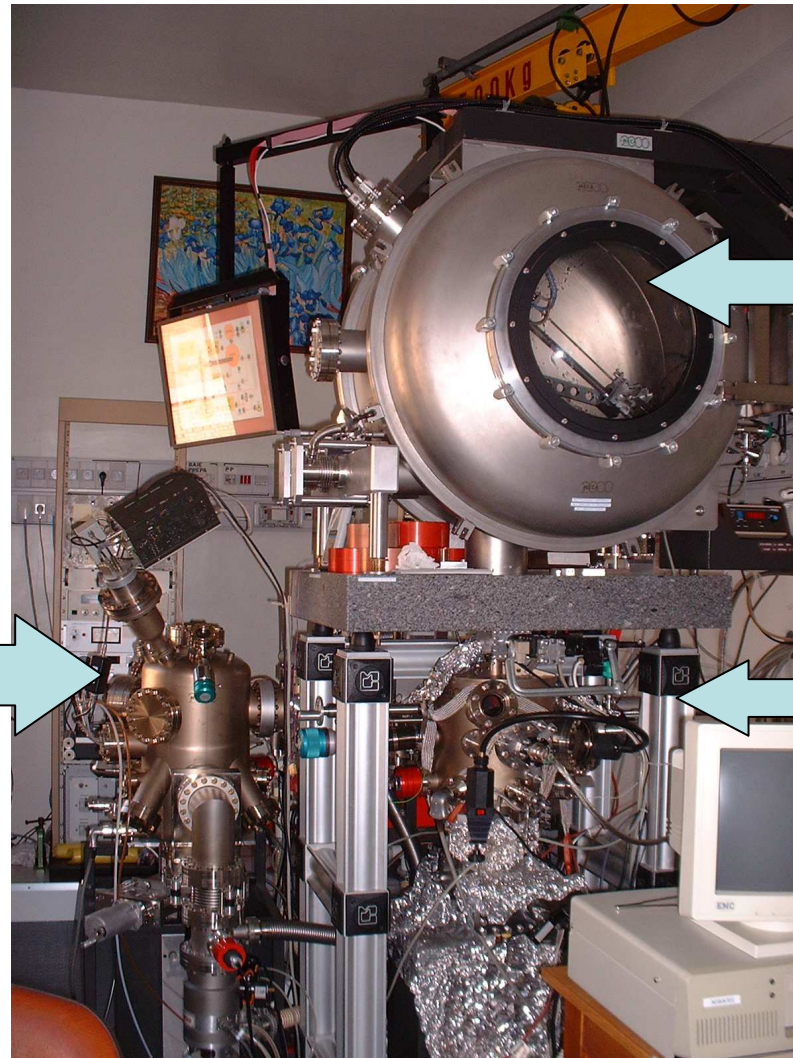
Studied emission : Si K β (3p \rightarrow 1s)



Analysis of the density of occupied Si 3p states

Identification and quantification of the Si-containing compounds

IRIS : Instrument de Recherche sur les Surfaces et les Interfaces



Preparation chamber

Spectrometer

Electron gun

Si K β spectra of the reference compounds

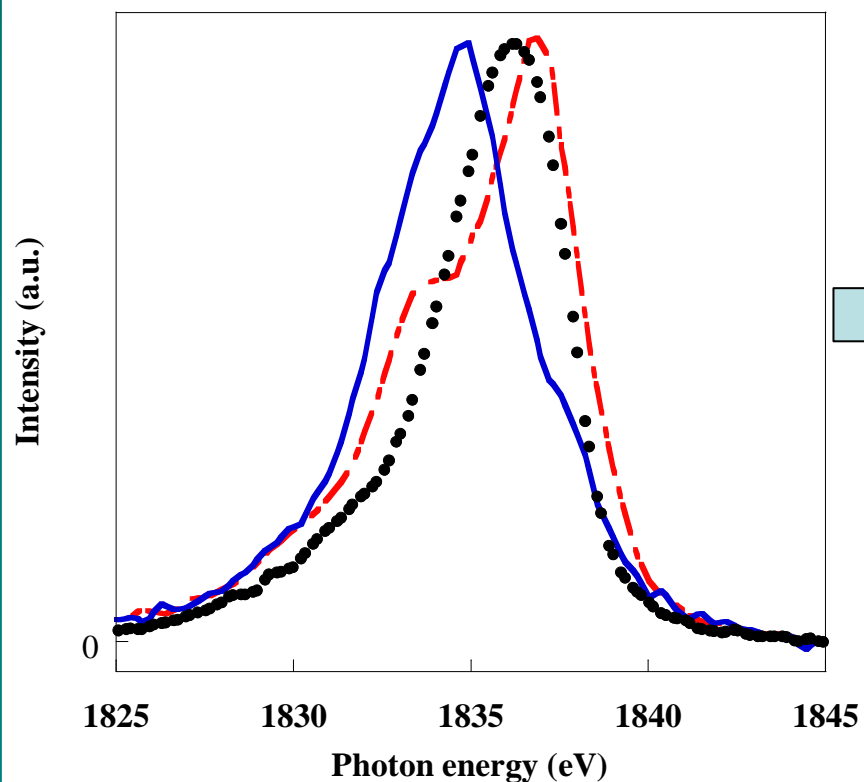


Parameters of the studied Mo / Si MIM prepared by ion beam sputtering

40 Mo / Si bilayers

$d_{\text{Mo}} = 2.92 \text{ nm}$, $d_{\text{Si}} = 4.04 \text{ nm}$

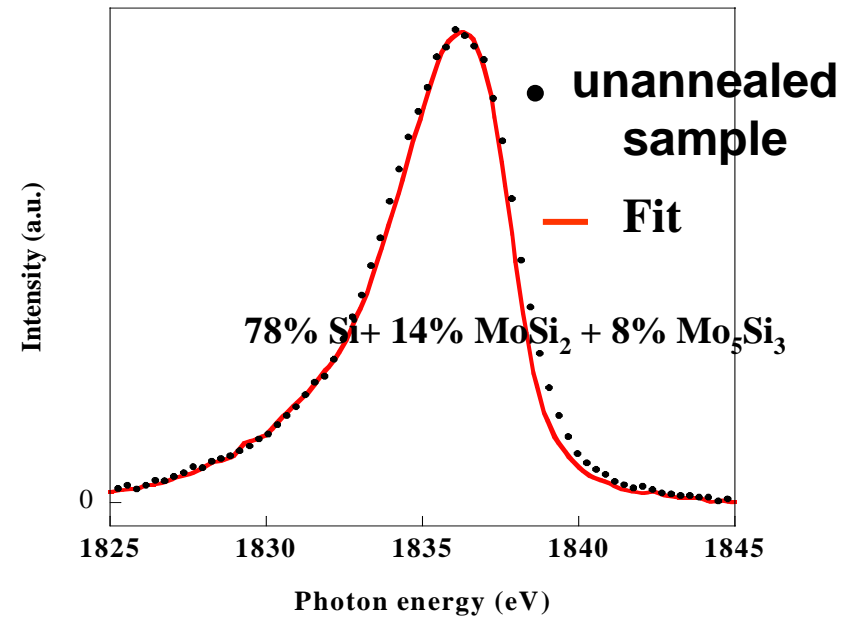
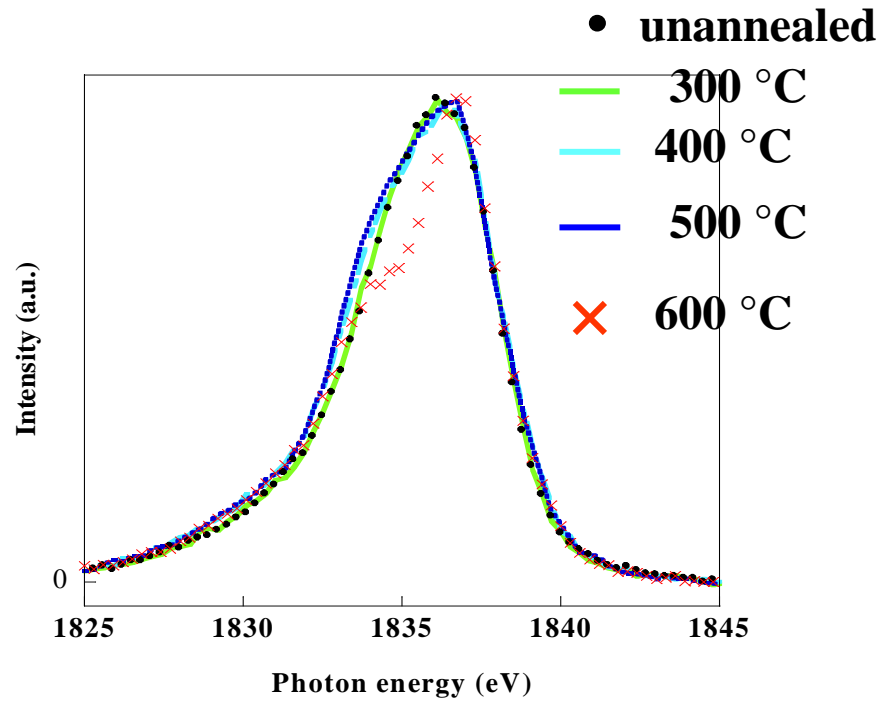
Substrate : silicon



Each reference compound has its own shape

Distinction between the physico-chemical states of the emitting silicon atoms

Study of the sample upon annealing



Results

sample	Unannealed	annealed 300°C	annealed 400 °C	annealed 500 °C	annealed 600°C
silicide contribution (%)	22	38	43	58	87



Increasing silicide contribution with increasing temperature

Determination of the interphase's thickness

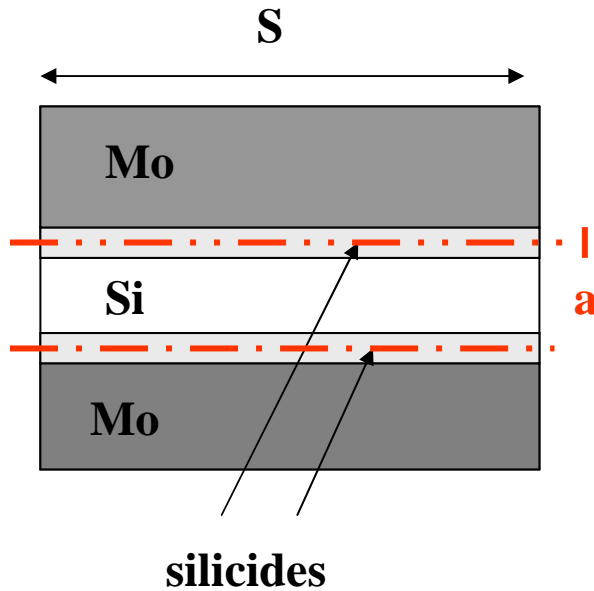


$$I_{MIM} = x \text{ Si} + y \text{ MoSi}_2 + z \text{ Mo}_5\text{Si}_3$$

$$\frac{I_{\text{interphase}}}{I_{\text{silicon}}} = \frac{\text{Number of emitting Si atoms interphase}}{\text{Number of emitting Si atoms Si layer}} = \frac{y+z}{x} = R$$

Interdiffusion model (MIYATA et al.)

$$I_{\text{Si}} \sim N_{\text{b atoms Si/cm}^3} \times \text{analysed volume}$$



$$I_{\text{interphase}} \sim \left[\frac{\rho}{M} \right]_{\text{interphase}} \times N \times 2a \times S$$

$$I_{\text{Si}} \sim \left[\frac{\rho}{M} \right]_{\text{Si}} \times N \times (d_{\text{Si}} - a) \times S$$

Determination of the interphase's thickness



$$\left(\frac{\rho}{M}\right)_{\text{interphase}} = 2a \times \left(\frac{\rho}{M}\right)_{\text{MoSi}_2} + 3b \times \left(\frac{\rho}{M}\right)_{\text{Mo}_5\text{Si}_3} \quad \text{with} \quad \begin{cases} I_{\text{silicides}} = a \text{ MoSi}_2 + b \text{ Mo}_5\text{Si}_3 \\ a + b = 1 \end{cases}$$

$$\left(\frac{\rho}{M}\right)_{\text{Si in MoSi}_2} = 2 \times \left(\frac{\rho}{M}\right)_{\text{MoSi}_2}$$

Finally,

$$a = \frac{R(\rho/M)_{\text{Si}} d_{\text{Si}}}{2(\rho/M)_{\text{int}} + R(\rho/M)_{\text{Si}}}$$


Results



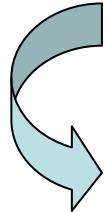
sample	Unannealed	annealed 300°C	annealed 400 °C	annealed 500 °C	annealed 600°C
transition layer (nm)	0.4	0.6	1.0	1.5	3.1

Interlayer thickness increases with the annealing temperature

1. Methodology Side

- XES suited tool for the study of buried interfaces
- From the silicides contribution  Determination of the transition layer's thickness

2. Material science side

- 
- Increasing of the silicides contribution and thus interlayer's thickness, with the increasing temperature from 300°C to 500°C
- Corelation with the optical performances :
- Decreasing of the reflectivity from 300 °C to 500 °C
 - Drastic change of the physico-chemical properties at 600 °C.